

# MegaMOS™FRED

## **IXTN36N50**

 $V_{DSS} = 500 V$ 

 $I_{D25} = 36 A$ 

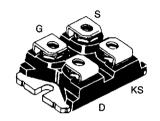
 $R_{DS(on)} = 0.12 \Omega$ 

N-Channel Enhancement Mode



Symbol	Test Conditions		Maximum Ratings		
V <sub>DSS</sub>	T <sub>1</sub> = 25°C to 150	D.C	500	٧	
V <sub>DGR</sub>	T <sub>J</sub> = 25°C to 150	0°C; R <sub>gs</sub> = 10 kΩ	500	٧	
V <sub>GS</sub>	Continuous		±20	٧	
V <sub>GSM</sub>	Transient		±30	٧	
i <sub>D25</sub>	T <sub>c</sub> = 25°C		36	Α	
I <sub>DM</sub>	T <sub>c</sub> = 25°C, pulse	e width limited by T <sub>JM</sub>	133	Α	
P <sub>D</sub>	T <sub>c</sub> = 25°C		400	w	
T <sub>J</sub>			-40 +150	°C	
T <sub>JM</sub>			150	°C	
T <sub>stg</sub>			-40 +150	°C	
V <sub>ISOL</sub>	50/60 Hz	t = 1 min	2500	V~	
1002	I <sub>ISOL</sub> ≤ 1 mA	t = 1 s	3000	V~	
M <sub>d</sub>	Mounting torque		1.5/13	Nm/lb.in.	
•	Terminal connec	tion torque (M4)	1.5/13	Nm/lb.in.	
Weight			30	g	

### miniBLOC, SOT-227 B



G = Gate,

D = Drain,

S = Source,

KS = Kelvin Source

#### **Features**

- International standard package miniBLOC (ISOTOP compatible)
- Isolation voltage 3000 V~
- Low  $R_{DS (on)} H \overline{DMOS^{TM}}$  process
- Rugged polysilicon gate cell structure
- Low drain-to-case capacitance (< 50 pF)</li>
- Low package inductance (< 10 nH)
  - easy to drive and to protect

Symbol	Test Conditions	Characteristic Value (T <sub>J</sub> = 25°C, unless otherwise specified min.   typ.   max.			
	· <u></u>		.yp.	,,,,,,,,	
V <sub>DSS</sub>	$V_{gs} = 0 V, I_{D} = 1 mA$	500			V
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 20 \text{ mA}$	2		4	V
I <sub>GSS</sub>	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$			±500	nA
I <sub>DSS</sub>	$V_{DS} = 0.8 \cdot V_{DSS}$ $V_{GS} = 0 V$	T <sub>J</sub> = 25°C T <sub>J</sub> = 125°C		400 2	μA mA
R <sub>DS(on)</sub>	$V_{gs} = 10 \text{ V}, I_{D} = 0.5 \bullet I_{D25}$ Pulse test, t ≤ 300 µs, duty c	ycle d ≤ 2 %		0.12	Ω

### **Applications**

- · AC motor speed control
- · DC servo and robot drives
- Uninterruptible power systems (UPS)
- Switch-mode and resonant-mode power supplies
- · DC choppers

#### **Advantages**

- · Easy to mount with 2 screws
- Space savings
- · High power density

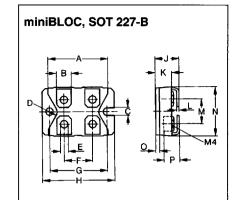
IXYS reserves the right to change limits, test conditions and dimensions.



Symbol	Fest Conditions Characteristic Values (T <sub>1</sub> = 25°C, unless otherwise specified			
	min.	typ.	max.	
9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}; I_{D} = 0.5 \cdot I_{D25}, \text{ pulsed}$ 30	38		S
C <sub>iss</sub>		8.5		nF
C <sub>oss</sub>	$\rangle$ V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz	0.9		nF
C <sub>rss</sub>		0.3		nF
t <sub>d(on)</sub>			100	ns
t,	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 I_{D25}$		110	ns
$\mathbf{t}_{d(off)}$	$R_{\rm g} = 1 \Omega$ , (External)		220	ns
t,			105	ns
Q <sub>g(on)</sub>	)	270	350	nC
$\mathbf{Q}_{gs}$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 I_{D25}$	60	90	nC
$\mathbf{Q}_{\mathrm{gd}}$	J	125	200	nC
R <sub>thJC</sub>			0.31	K/W
R <sub>thCK</sub>		0.05		K/W

Source-Drain Diode		Characteristic Values		
Symbol	Test Conditions	$(T_J = 25^{\circ}C)$ , unless otherwise specified min.   typ.   max.		
Symbol	Test Conditions	. 3		-

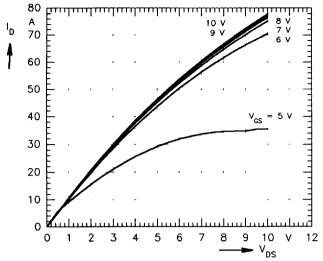
Symbol	rest conditions	typ.	IIIax.	
I <sub>s</sub>	V <sub>GS</sub> = 0		36	Α
I <sub>sm</sub>	Repetitive; pulse width limited by $T_{_{JM}}$		144	Α
V <sub>sp</sub>	$I_F = I_S, V_{GS} = 0 \text{ V},$ Pulse test, $t \le 300 \mu\text{s}$ , duty cycle d $\le 2 \%$		1.5	V
t <sub>rr</sub>	$I_F = I_S$ , -di/dt = 100 A/ $\mu$ s, $V_B = 100 \text{ V}$	600		ns



M4 screws (4x) supplied

Dım.	Millimeter		Inch	es
	Mın.	Max.	Mın.	Max.
Α	31.5	31.7	1.241	1.249
В	7.8	8.2	0.307	0.323
С	40	-	0.158	-
D	41	4.3	0.162	0.169
E	41	43	0 162	0.169
F	14 9	15 1	0 587	0.595
G	30 1	30 3	1 186	1 193
H	38.0	38 2	1 497	1.505
J	118	122	0 465	0.481
K	89	9.1	0.351	0.359
L	0.75	0.85	0.030	0.033
М	12.6	12.8	0.496	0.504
N	25.2	25.4	0.993	1.001
0	1.95	2.05	0.077	0.081
Р	-	5.0	-	0.197







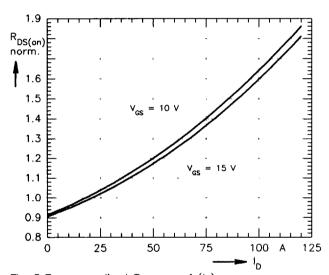


Fig. 3 Typ. normalized  $R_{DS(on)} = f(I_D)$ 

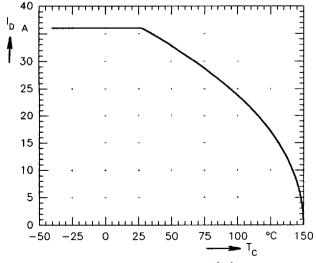


Fig. 5 Continuous drain current  $I_D = f(T_C)$ 

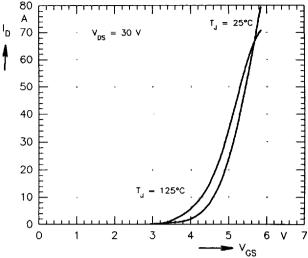


Fig. 2 Typ. transfer characteristics,  $I_D = f(V_{GS})$ 

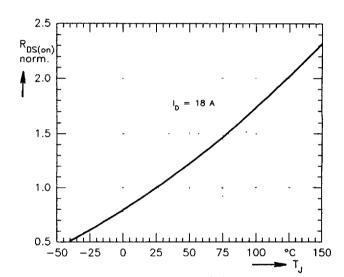


Fig. 4 Typ. normalized  $R_{DS(on)} = f(T_J)$ 

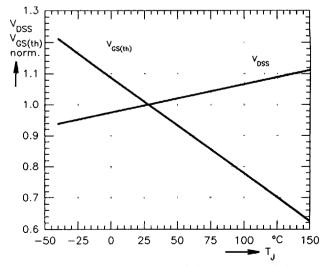


Fig. 6 Typ. normalized  $V_{DSS} = f(T_J)$ ,  $V_{GS(th)} = f(T_J)$ 

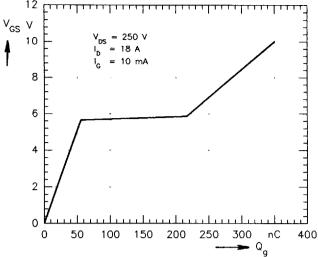


Fig. 7 Typ. turn—on gate charge characteristics,  $V_{\rm GS} = f \, (Qg)$ 

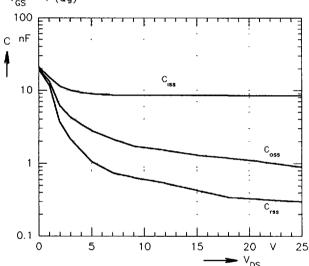


Fig. 9 Typ. capacitances  $C = f(V_{DS})$ , f = 1 MHz

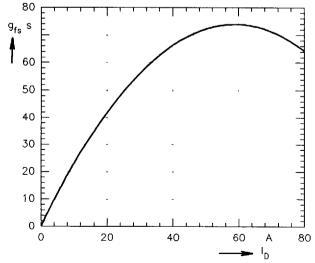


Fig. 11 Typ. transconductance,  $g_{fs} = f (I_D)$ 

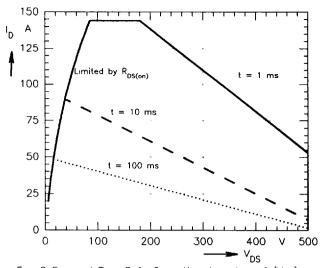


Fig. 8 Forward Bias Safe Operating Area  $I_D = f(V_{DS})$ 

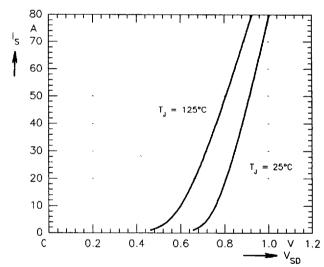


Fig. 10 Typ. forward characteristics of reverse diode  $I_S = f(V_{SD})$ 

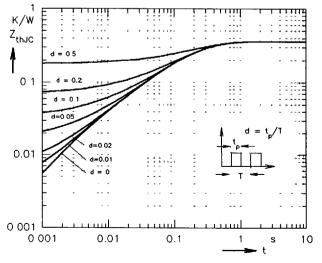


Fig. 12 Transient thermal resistance,  $Z_{thJC} = f(t)$ 

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